

**PATENT ASSIGNMENT**

Electronic Version v1.1  
 Stylesheet Version v1.1

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Hideki Katsura	09/01/2011
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Terumo Kabushiki Kaisha
<b>Street Address:</b>	44-1, Hatagaya 2-chome, Shibuya-ku
<b>City:</b>	Tokyo
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	151-0072
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	29403747
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	8942-100719-US
<b>NAME OF SUBMITTER:</b>	Stephen S. Favakeh
<b>Total Attachments: 2</b> source=8942-100719Assignment#page1.tif source=8942-100719Assignment#page2.tif	

CH \$40.00 29403747

ASSIGNMENT

I, Hideki KATSURA, of Tokyo, Japan, a citizen of Japan, for good and valuable consideration, receipt of which is hereby acknowledged, have assigned and do hereby assign to Terumo Kabushiki Kaisha, a corporation of Japan, having its principal place of business at 44-1, Hatagaya 2-chome, Shibuya-ku, Tokyo 151-0072, Japan, its successors, assigns and legal representatives, the entire right, title and interest, in and to all subject matter invented by me and disclosed in the application for Letters Patent of the United States entitled

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signed by me on this date; and in and to all Letters Patent and all Convention and Treaty rights of all kinds, including the right to claim priority from said application, and all rights in and to any continuation, continuation-in-part, and divisional application therefrom, and any reissue or re-examination as to any Letters Patent issuing therefrom, in all countries throughout the world, for all such subject matter described therein, including all rights of action and rights to recover damages for past infringements. I agree to sign all documents necessary to secure all said Letters Patent and rights, and request issuance of all said Letters Patent to the above assignee in accordance with this assignment.

I hereby authorize and request my attorneys, Fitch, Even, Tabin & Flannery, of 120 South LaSalle Street, Suite 1600, Chicago, Illinois 60603-3406, to insert here in parenthesis (Application No. 29/403,747, filed October 11, 2011) the filing date and application number of said application when known.

SEP 1, 2011

Hideki Katsura

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